17 - 21 GHz



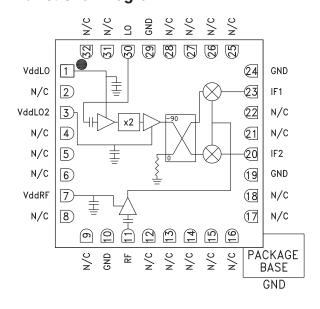


Typical Applications

The HMC570LC5 is ideal for:

- Point-to-Point and Point-to-Multi-Point Radio
- Military Radar, EW & ELINT
- Satellite Communications

Functional Diagram



Features

10 dB Conversion Gain Image Rejection: 18 dB 2 LO to RF Isolation: 65 dB

Noise Figure: 3 dB Input IP3: +2 dBm

32 Lead 5x5mm SMT Package: 25mm²

General Description

The HMC570LC5 is a compact GaAs MMIC I/Q downconverter in a leadless RoHS compliant SMT package. This device provides a small signal conversion gain of 10 dB with a noise figure of 3 dB and 18 dB of image rejection across the frequency band. The HMC570LC5 utilizes an LNA followed by an image reject mixer which is driven by an active x2 multiplier. The image reject mixer eliminates the need for a filter following the LNA, and removes thermal noise at the image frequency. I and Q mixer outputs are provided and an external 90° hybrid is needed to select the required sideband. The HMC570LC5 is a much smaller alternative to hybrid style image reject mixer downconverter assemblies, and it eliminates the need for wire bonding by allowing the use of surface mount manufacturing techniques.

Electrical Specifications, $T_{\Delta} = +25^{\circ}$ C, IF = 100 MHz, LO = +4 dBm, Vdd = 3.5 Vdc*

Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range, RF		17.7 - 19.7			17 - 21	,	GHz
Frequency Range, LO	7 - 12			7 - 12			GHz
Frequency Range, IF	DC - 3.5			DC - 3.5			GHz
Conversion Gain (As IRM)	9	10		8	10		dB
Noise Figure		3			3		dB
Image Rejection	14	17		14	22		dB
1 dB Compression (Input)	-5	-4		-10	-5		dBm
2 LO to RF Isolation	55	70		50	60		dB
2 LO to IF Isolation	35	50		35	45		dB
IP3 (Input)	-5	-2		-5	+2		dBm
Amplitude Balance		0.5			0.5		dB
Phase Balance		12			4		Deg
Total Supply Current		125	165		125	165	mA

^{*}Data taken as IBM with external IF Hybrid



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Data Taken As IRM With External IF Hybrid

Conversion Gain vs. Temperature

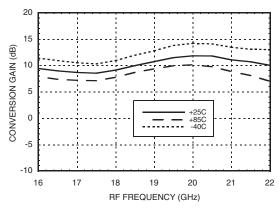
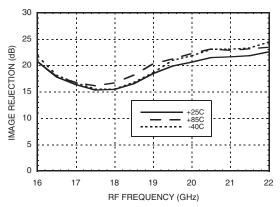
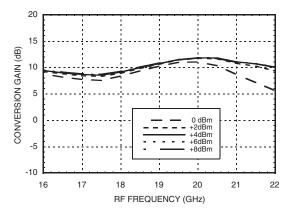


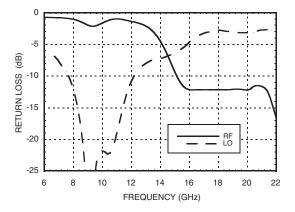
Image Rejection vs. Temperature



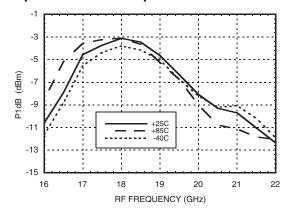
Conversion Gain vs. LO Drive



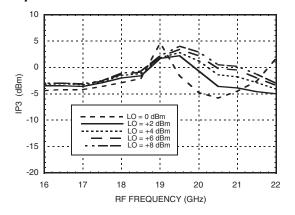
Return Loss



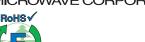
Input P1dB vs. Temperature



Input IP3 vs. LO Drive



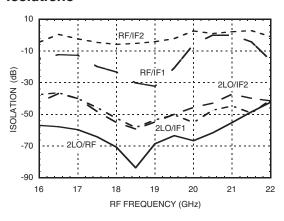




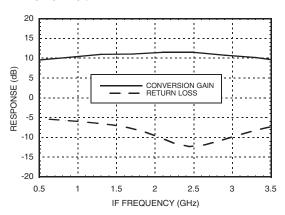
GaAs MMIC I/Q DOWNCONVERTER 17 - 21 GHz

Quadrature Channel Data Taken Without IF Hybrid

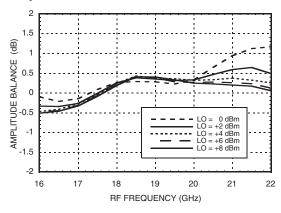
Isolations



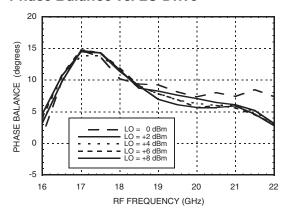
IF Bandwidth*



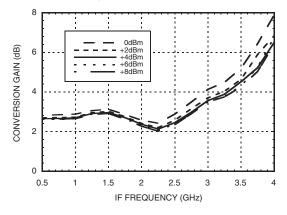
Amplitude Balance vs. LO Drive



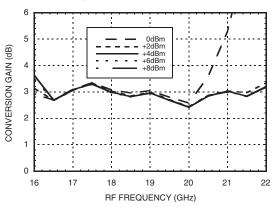
Phase Balance vs. LO Drive



Noise Figure vs. LO Drive, LO Frequency = 8.6 GHz



Noise Figure vs. LO Drive, IF Frequency = 100 MHz



^{*} Conversion gain data taken with external IF hybrid, LO frequency fixed at 8.6 GHz and RF varied





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MxN Spurious Outputs

	nLO				
mRF	0	1	2	3	4
0	xx	21	25	32	35
1	32	26	0	25	41
2	54	81	69	61	46
3	xx	xx	xx	79	79
4	xx	xx	xx	xx	xx

RF = 18 GHz @ -20 dBm LO = 8.5 GHz @ +4 dBm

Data taken without IF hybrid

All values in dBc below IF power level (1RF -2LO = 1 GHz)

Absolute Maximum Ratings

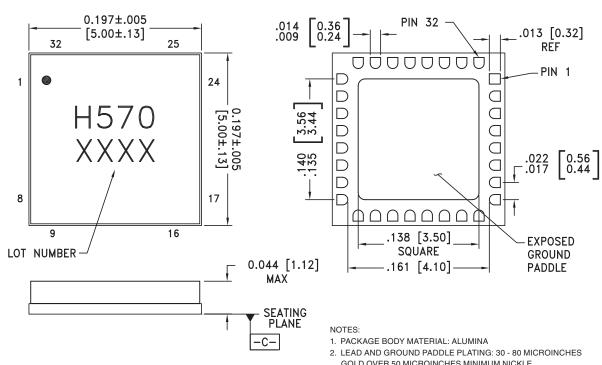
2 dBm
13 dBm
5.5V
175°C
860 mW
104.6 °C/W
-65 to +150 °C
-55 to +85 °C
Class 1B



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

Outline Drawing

BOTTOM VIEW



- GOLD OVER 50 MICROINCHES MINIMUM NICKLE
- 3. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm DATUM
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND

rder OII-life at www.hittite



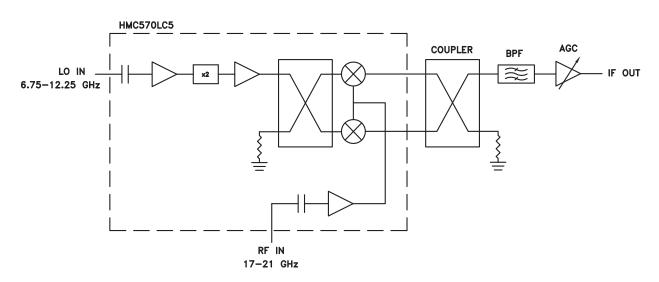


GaAs MMIC I/Q DOWNCONVERTER 17 - 21 GHz

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1	VddLO	Power supply for first stage of LO amplifier.	VddLO ○ — — —
2, 4 - 6, 8, 9, 12 - 18, 21, 22, 25 - 28, 31, 32	N/C	No connection required. These pins may be connected to RF/DC ground without affecting performance.	
3	VddLO2	Power supply for second stage of LO amplifier.	VddLO2 ○─── = =
7	VddRF	Power supply for RF LNA.	VddRF ○──── ──── ───
10, 19, 24, 29	GND	These pins and ground paddle must be connected to RF/DC ground.	GND =
11	RF	This pin is AC coupled and matched to 50 Ohms	RF ○── ├──
20	IF2	This pin is DC coupled for applications not requir- ing operation to DC. This port should be DC blocked externally using a series capacitor whose value has	IF1,IF2 O
23	IF1	been chosen to pass the necessary frequency range. For operation to DC, this pin must not sink / source more than 3 mA of current or part non-function and possible failure will result.	
30	LO	This pin is AC coupled and matched to 50 Ohms.	ьо ०—├—

Typical Application



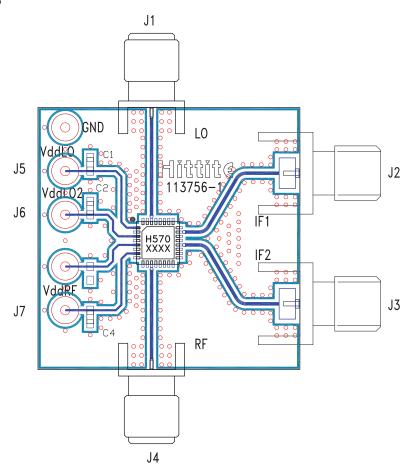


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GaAs MMIC I/Q DOWNCONVERTER 17 - 21 GHz

Evaluation PCB



List of Materials for Evaluation PCB 113758 [1]

Item	Description	
C1 - C4	Capacitor 0603, 0.01 µF	
J1, J4	PCB Mount SMA RF Connector, SRI	
J2, J3	PCB Mount SMA Connector, Johnson	
J5 - J7	DC Pin	
U1	HMC570LC5	
PCB [2]	113756 Evaluation Board	

^[1] Reference this number when ordering complete evaluation PCB

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

^[2] Circuit Board Material: Rogers 4350